

EDGE™ Module

The Corning logo is a solid blue square with the word "CORNING" in white, uppercase, sans-serif font centered within it.

CORNING

EDGE™ low-loss modules provide an interface between the MTP® connector on an MTP trunk and the LC duplex jumpers that connect directly to the electronics. These modules feature VFL-compatible LC shuttered adapters and are manufactured with Corning® CleanAdvantage™ Technology, an innovative factory cleaning and sealing process that minimizes debris transfer and allows you to connect with confidence.

All EDGE modules meet RoHS standards and are ideal for data center, local area network (LAN), and storage area network (SAN) applications.

Specifications

General Specifications

Product Type	Panels and Modules
Application	Data Center LAN/SAN

Standards

RoHS	Free of hazardous substances according to RoHS 2011/65/EU
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Design

Housing Type	Modules
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Ordering Information

Part Number	Product Description	Units Per Delivery
ECM-RM12-05-93T	12F, 50 µm multimode (OM3)	Piece
ECM-UM12-04-89G	12 F, LC Duplex to MTP® Connector, Bend-improved single-mode (OS2)	Piece
ECM-UM12-05-93Q	12 F, 50 µm (OM4), LC Duplex, PC, MTP® PC, Connector (pinned), multimode	Piece
ECM-UM12-05-93T	12 F, 50 µm (OM3), LC Duplex, PC, MTP® PC, Connector (pinned), multimode	Piece
ECM-UM12-18-89G	12F, Bend-improved Single-mode (OS2)	Piece



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